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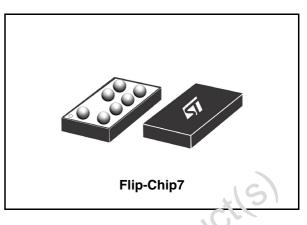


## STG4159

Low voltage  $0.3\Omega$  max single SPDT switch with break-before-make feature and 10kV contact ESD protection

### Features

- Wide operating voltage range:
  V<sub>CC</sub> (OPR) = 1.65V to 4.8V
- Low power dissipation: I<sub>CC</sub> = 0.2µA (max.) at T<sub>A</sub> = 85°C
- Low "ON" resistance V<sub>IN</sub> = 0V:
  - $R_{ON}$  = 0.40 $\Omega$  (max.  $T_{A}$  = 25°C) at  $V_{CC}$  = 2.25V
  - $R_{ON} = 0.35\Omega$  (max.  $T_A = 25^{\circ}C$ ) at  $V_{CC} = 3.0V$
  - $R_{ON} = 0.30\Omega$  (max.  $T_A = 25^{\circ}C$ ) at  $V_{CC} = 4.3V$
- Separate supply voltage for switch and control pin
- Latch-up performance exceeds 100mA per JESD 78, Class II
- ESD performance tested on common channel (D pin)
  - 10kV IEC-61000-4-2 ESD, contact discharge
  - 15kV IEC-61000-4-2 ESD, air discharge
- ESD performance test on all other pins
  - 10kV IEC-61000-4-2 ESD, contact discharge
  - 500V machine model (JE3D22 A115-A)
- 1500V chargcd-device model (JESD22 C10.)



### Description

The STG4159 is a high-speed CMOS low voltage single analog SPDT Single Pole Dual Throw) switch or 2:1 multiplexer/demultiplexer switch fabricated in sinicon gate C<sup>2</sup>MOS technology. It is designed to operate from 1.65V to 4.58V, making this device ideal for portable applications. It offers tow ON-resistance ( $0.45\Omega$ ) at V<sub>CC</sub> = 4.3V. The SEL inputs are provided to control the switches.

The switch S1 is ON (connected to common Port D) when the SEL input is held high and OFF (high impedance state exists between the two ports) when SEL is held low; the switch S2 is ON (it is connected to common Port D) when the SEL input is held low and OFF (high impedance state exist between the two ports) when SEL is held high.

Additional key features are fast switching speed, break-before-make delay time and ultra low power consumption. All inputs and outputs are equipped with protection circuits against static discharge, giving them ESD immunity and transient excess voltage.

Table 1.	Device	summary
	Device	Summary

Part number	Package	Packaging
STG4159	Flip-Chip7	Tube
STG4159BJR	Flip-Chip7	Tape and reel

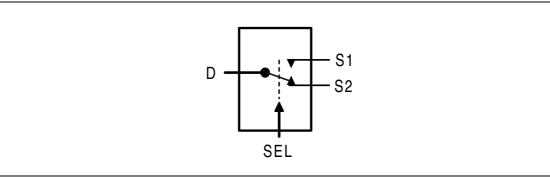
### Contents

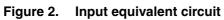
1	Logic diagram
2	Maximum rating
3	Electrical characteristics6
4	Test circuits
5	Package mechanical data 12
6	Package mechanical data

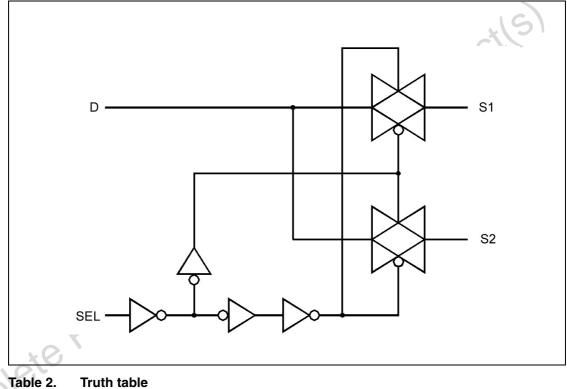


#### Logic diagram 1









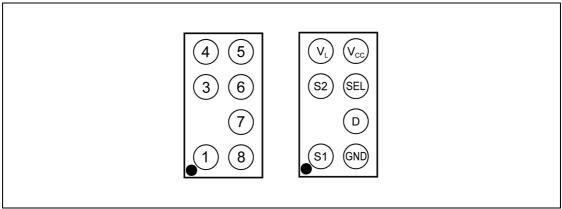
Truth table

SEL	Switch S1	Switch S2
Н	ON	OFF <sup>(1)</sup>
L	OFF <sup>(1)</sup>	ON

1. High Impedance



Figure 3.	Pin connection	(bump side view)
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### Table 3. Pin description

	Flip-Chip	Symbol	Name and function
	1, 3	S1, S2	Independent channels
	7	D	Common channel
	6	SEL	Control
	5	V <sub>CC</sub>	Positive supply voltage
	4	VL	Logic supply voltage
	8	GND	Ground (0V)
050	lete Produ		



### 2 Maximum rating

Stressing the device above the rating listed in the "Absolute maximum ratings" table may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in the Operating sections of this specification is not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability. Refer also to the STMicroelectronics SURE Program and other relevant quality documents.

Symbol	Parameter	Value	Unit
V <sub>CC</sub>	Supply voltage	-0.5 to 5.5	V
VL	Logic supply voltage	-0.5 to 5.5	V
VI	DC input voltage	-0.5 to V <sub>CC</sub> + 0.5	V
V <sub>IC</sub>	DC control input voltage	-0.5 to V <sub>L</sub> + 0.5	v
Vo	DC output voltage	-0.5 to V <sub>CC</sub> + 0.5	v
I <sub>IKC</sub>	DC input diode current on control pin (V <sub>SEL</sub> < 0V)	-50	mA
I <sub>IK</sub>	DC input diode current (V <sub>SEL</sub> < 0V)	±50	mA
Ι <sub>ΟΚ</sub>	DC output diode current	±20	mA
Ι <sub>Ο</sub>	DC output current	±300	mA
I <sub>OP</sub>	DC output current peak (pulse at 1ms, 10% duty cycle)	±500	mA
$I_{\rm CC}$ or $I_{\rm GND}$	DC V <sub>CC</sub> or ground current	±100	mA
P <sub>D</sub>	Power dissipation at $T_A = 70^{\circ}C^{(1)}$	500	mW
T <sub>stg</sub>	Storage temperature	-50 to 105	°C
TL	Lead temperature (10 sec)	260	°C

Table 4. Absolute maximum ratings

1. Derate above 70°C by 18.5mW/C

### Table 5. Recommended operating conditions

	Symbol	Parameter		Value	Unit
	V <sub>CC</sub>	Supply voltage <sup>(1)</sup>		1.65 to 4.8	V
	VL	Logic supply voltage (2)		1.65 to V <sub>CC</sub>	V
10SU	VI	Input voltage		0 to V <sub>CC</sub>	V
70-	V <sub>IC</sub>	Control input voltage	0 to V <sub>L</sub>	V	
	V <sub>O</sub>	Output voltage	0 to V <sub>CC</sub>	V	
	T <sub>op</sub>	Operating temperature		-40 to 85	°C
	dt/dv	Input rise and fall time control input	V <sub>L</sub> = 1.65V to 2.7V	0 to 20	ns/V
	uvuv		$V_{L} = 3.0V$ to 4.8V	0 to 10	- 113/ V

1. Truth Table guaranteed: 1.65V to 4.8V

2. V<sub>L</sub> pin should not be left floating.



### **3** Electrical characteristics

	Table 6.	DC specifications				Value									
				Test condi	tions			Value							
	Symbol	Parameter	V <sub>cc</sub> (V)	V <sub>L</sub> (V)		T,	<sub>A</sub> = 25°	°C	-40 to	85°C	Unit				
			• • • • • • •	• [ (•)		Min.	Тур.	Max.	Min.	Max.					
				1.65-1.95		1.25			1.25						
	V <sub>IH</sub>	High level input	1.65-4.3	2.3-2.7		1.75			1.75		v				
	▼ IH	voltage	1.05-4.5	3.0-3.6		2.35			2.35		v				
				4.3		2.8			2.8						
				1.65-1.95				0.6		0.6					
	V <sub>IL</sub>	Low level input	1.65-4.3	2.3-2.7				0.8		0.8	v				
	۴IL	voltage	1.00-4.0	3.0-3.6				1.05	A.	1.05	v				
				4.3				1.5	. C.	1.5	,				
			1.8				0.49	0.65	5	0.85					
			2.25		Va=0V to Vaa		0.30	0.40	k	0.50					
	R <sub>ON</sub>	ON resistance	3	1.65-4.3	V <sub>S</sub> =0V to V <sub>CC</sub> I <sub>S</sub> =100mA		0.25	0.35		0.45	Ω				
			3.7		15-10011/1	0	0.22	0.32		0.42					
			4.3		10		0.21	0.30		0.40					
			1.8		c0'		5								
		ON resistance	2.25		V <sub>S</sub> =0V to V <sub>CC</sub>		3								
	$\Delta R_{ON}$	match between	3	1.65-4.3	I <sub>S</sub> =100mA		3				mΩ				
		channels <sup>(1)</sup>	3.7						.5		3				
			4.3				3								
			1.8				300	400		450					
		ON resistance	2.5		Va-0V to Vaa		130	170		230	1				
	R <sub>FLAT</sub>	flatness <sup>(2)</sup>	3	1.65 - 4.3	$V_S=0V$ to $V_{CC}$ $I_S=100mA$		90	120		170	mΩ				
		liainees	3.7		.5		90	120		170					
	d'		4.3				90	120		170					
) <sup>050</sup>	I <sub>OFF</sub>	Sn OFF state leakage current	1.65-4.3	1.65 - 4.3	$V_{S}$ =0 to $V_{CC}$ $V_{D}$ =0 to $V_{CC}$	-20		20	-300	300	nA				
	I <sub>ON</sub>	Sn ON state leakage current	1.65-4.3	1.65 - 4.3	V <sub>S</sub> =0 to V <sub>CC</sub> V <sub>D</sub> =Open	-20		20	-100	100	nA				
	۱ <sub>D</sub>	D ON state leakage current	1.65-4.3	1.65 - 4.3	V <sub>S</sub> =Open V <sub>D</sub> =0 to V <sub>CC</sub>	-20		20	-100	100	nA				

### Table 6.DC specifications



Symbol Parameter		Test conditions								
	V <sub>CC</sub> (V) V <sub>L</sub> (V)				T <sub>A</sub> = 25°C			-40 to 85°C		
			• [ (• )		Min.	Тур.	Max.	Min.	Max.	
I <sub>CC</sub>				V <sub>SEL</sub> =V <sub>CC</sub> or GND	-0.05		0.05	-0.2	0.2	μA
I <sub>SEL</sub>	SEL leakage current	1.65-4.3	1.65 - 4.3	V <sub>SEL</sub> =4.3V or GND	-0.1		0.1	-1	1	μA

Table 6.DC specifications

1.  $\Delta R_{ON} = R_{ON(Max)} - R_{ON(Min)}$ 

 Flatness is defined as the difference between the maximum and minimum value of on-resistance as measured over the specified analog signal ranges.

			Test conditions					Value					
	Symbol	Parameter	V <sub>CC</sub> (V)	V <sub>L</sub> (V)		T,	<sub>A</sub> = 25°	С	-40 to	85°C	Unit		
			VCC (V)	<b>v</b> ∟( <b>v</b> )		Min.	Тур.	Max.	Min.	Max.			
			1.65-1.95				0.13		5				
	t <sub>PLH</sub> ,	Propagation	2.3-2.7	1.65-4.3			0.15	0			ns		
	t <sub>PHL</sub>	delay	3.0-3.3	1.05-4.5		. 0	0.16				115		
			3.6-4.3		10		0.16						
			1.65-1.95				95	123		160			
	t <sub>ON</sub>	TURN-ON	2.3-2.7	1.65-4.3	$V_{S} = V_{CC}$ R <sub>L</sub> = 500		48	62		80	ns		
	SON	time	3-3.6		1.00 1.0	1.00 1.0	$C_L = 30 pF$		33	43		56	113
			4.3				29	38		49			
			1.65-1.95	51	V _ V		12	15		20			
	t <sub>OFF</sub>	TURN-OFF	2.3-2.7	1.65-4.3	$V_{S} = V_{CC}$ R <sub>1</sub> = 500		12	16		21	ns		
	OFF	time	3-3.6		$C_L = 30pF$		13	17		22	110		
		0	4.3		_		13	17		22			
		X	1.65-1.95		C 35nE	10	42						
	t <sub>D</sub>	Break- before-make	2.3-2.7	1.65-4.3	C <sub>L</sub> = 35pF R <sub>L</sub> = 50Ω	10	22				ns		
c0		time delay	3-3.6		$V_{\rm S} = V_{\rm CC}/2$	5	15						
~105 <sup>0</sup>			4.3			5	12						
00			1.65-1.95				83						
	Q	Charge	2.3-2.7	1.65-4.3	C <sub>L</sub> = 1nF V <sub>GEN</sub> = 0V		98				рС		
	3	injection	3.0-3.3		$V_{GEN} = 0V$		114						
			3.6-4.3				140						

Table 7.AC electrical characteristics ( $C_L = 35pF$ ,  $R_L = 50\Omega$ ,  $t_r = t_f \le 5ns$ )



		Test conditions								
Symbol	Parameter	V <sub>cc</sub> (V)	V <sub>L</sub> (V)		Т	<sub>A</sub> = 25°	с	-40 to	85°C	Unit
		VCC (V)	v <sub>L</sub> (v)		Min.	Тур.	Max.	Min.	Max.	
OIRR	Off Isolation	1.65-4.3	4.3	V <sub>S</sub> = 1V <sub>RMS</sub> f = 100kHz		-69				dB
Xtalk	Crosstalk	1.65-4.3	4.3	V <sub>S</sub> = 1V <sub>RMS</sub> f = 100kHz		-69				dB
THD	Total harmonic distortion	2.3-4.3	4.3	$R_{L} = 600\Omega$ $C_{L} = 50pF$ $V_{S} = V_{CC} V_{PP}$ $f = 600Hz to$ $20kHz$		0.01				%
BW	-3dB Bandwidth (switch ON)	1.65-4.3	4.3	R <sub>L</sub> = 50Ω		28		۲Ċ	6	MHz
C <sub>SEL</sub>	Control pin input capacitance	1.8-4.3	1.8-4.3	$V_L = V_{CC}$		30	00	0		
C <sub>Sn</sub>	Sn port capacitance	1.8-4.3	1.8-4.3	$V_L = V_{CC}$	10	94				pF
CD	D port capacitance when switch is enabled	1.8-4.3	1.8-4.3	V <sub>L</sub> = V <sub>CC</sub>		227				

Table 8.Analog switch characteristics ( $C_L = 5pF$ ,  $R_L = 50\Omega$ ,  $T_A = 25^{\circ}C$ )

1. OFF-isolation = 20 log<sub>10</sub> (VD/VS), V<sub>D</sub> = output, V<sub>S</sub> = input to off switch



### 4 Test circuits

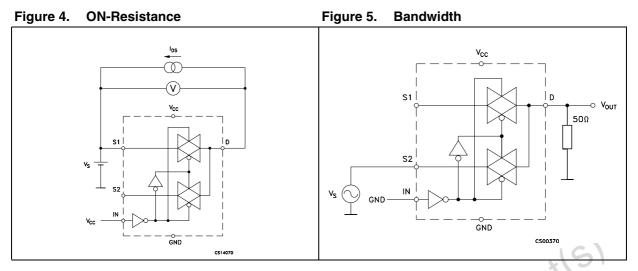
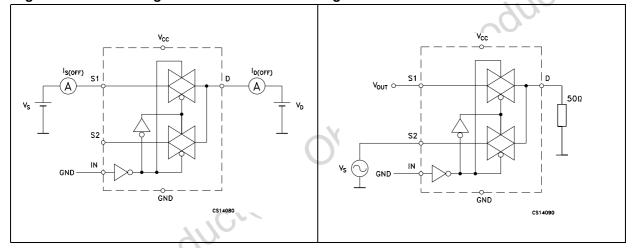
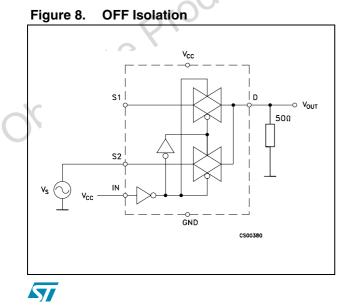




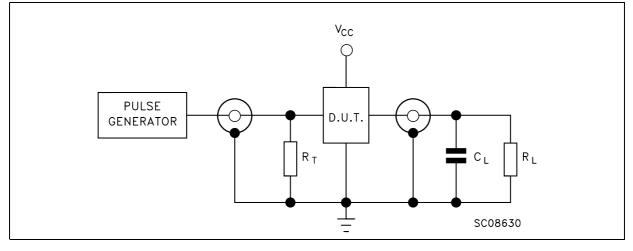
Figure 7. Channel to channel crosstalk





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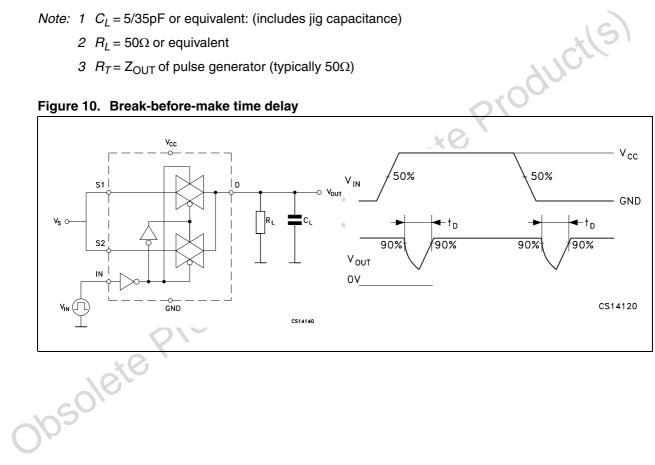
#### **Test circuit** Figure 9.



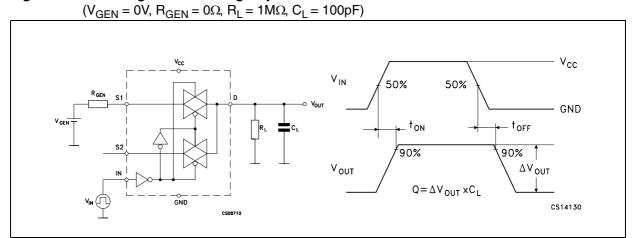
*Note:* 1  $C_L = 5/35$  pF or equivalent: (includes jig capacitance)

- 2  $R_L = 50\Omega$  or equivalent
- 3  $R_T = Z_{OUT}$  of pulse generator (typically 50 $\Omega$ )

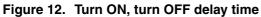


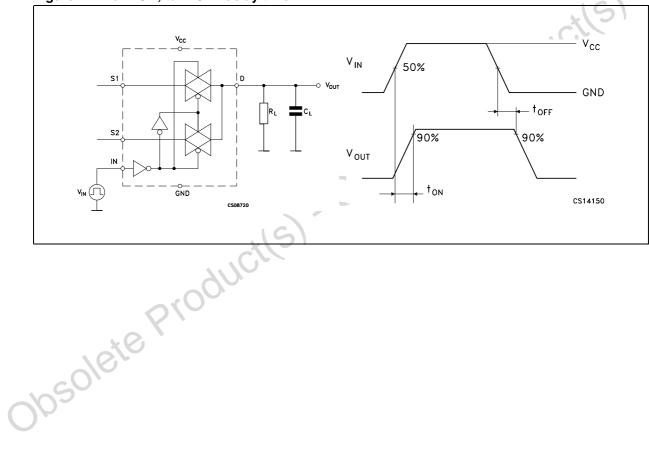






### Figure 11. Switching time and charge injection







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### 5 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK<sup>®</sup> packages. These packages have a Lead-free second level interconnect. The category of second Level Interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

obsolete Product(s). Obsolete Product(s)

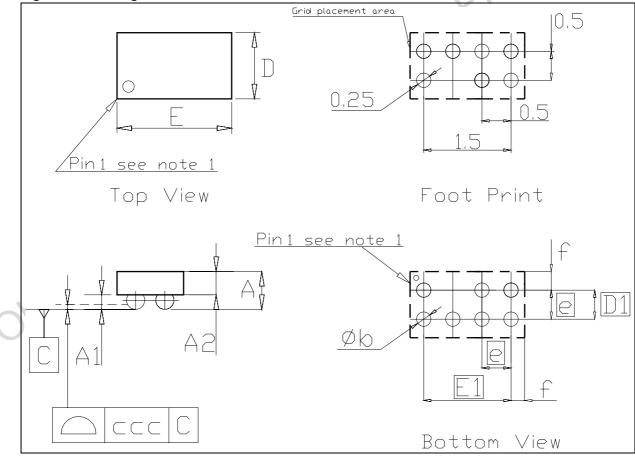
Dim.	Data book (mm)			Drawing (mm)		
	Min	Тур	Мах	Min	Тур	Max
А	0.585	0.65	0.715	0.60	0.65	0.70
A1	0.21	0.25	0.29	0.22	0.25	0.28
A2		0.4		0.38	0.4	0.42
b	0.265	0.315	0.365	0.290	0.315	0.340
D	1.018	1.068	1.118	1.053	1.068	1.083
D1		0.5		0.49	0.5	0.51
E	2.018	2.068	2.118	2.053	2.068	2.083
E1		1.5		1.49	1.5	1.51
е	0.45	0.5	0.55	0.46	0.5	0.54
f		0.284		0.272	0.284	0.292
CCC		0.08			0.08	

#### Table 9.Flip-Chip7 mechanical data

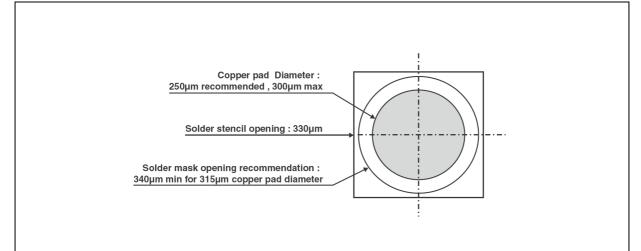
Note: 1 The terminal Pin 1 on the bumps side is identified by a distinguishing feature (for instance by a circular "clear area" - typically 0.1mm diameter - ) The terminal Pin 1 on the backside of the product is identified by a distinguishing feature (for instance by a circular "dot" - typically 0.5mm diameter - ).

Figure 13. Package dimensions

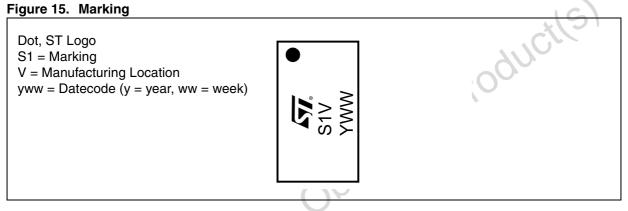
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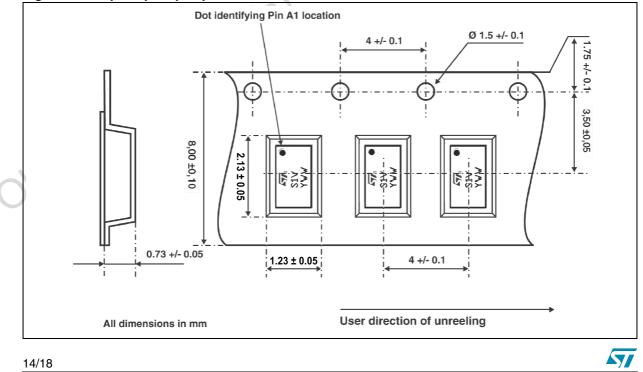
#### Figure 14. Foot print recommendations



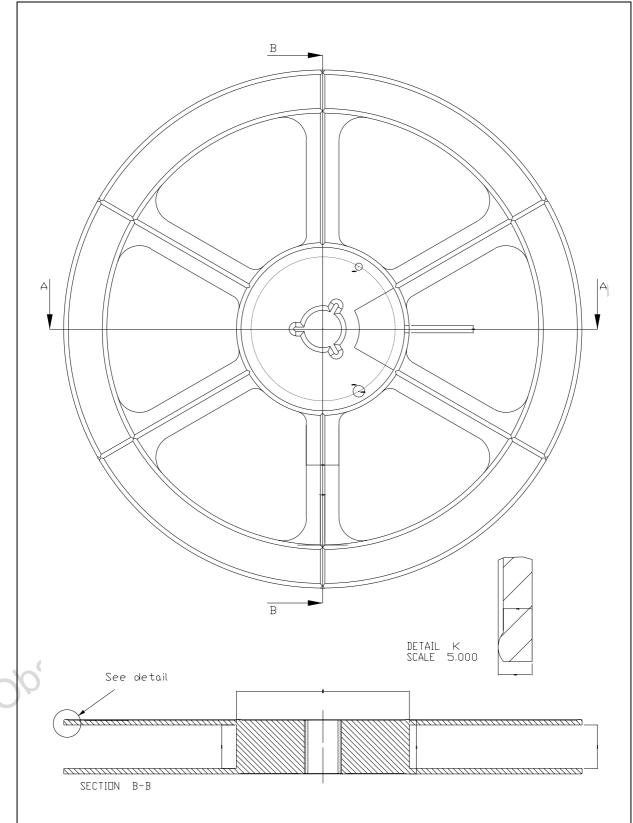
#### Figure 15. Marking



#### Figure 16. Flip-Chip7 tape specification



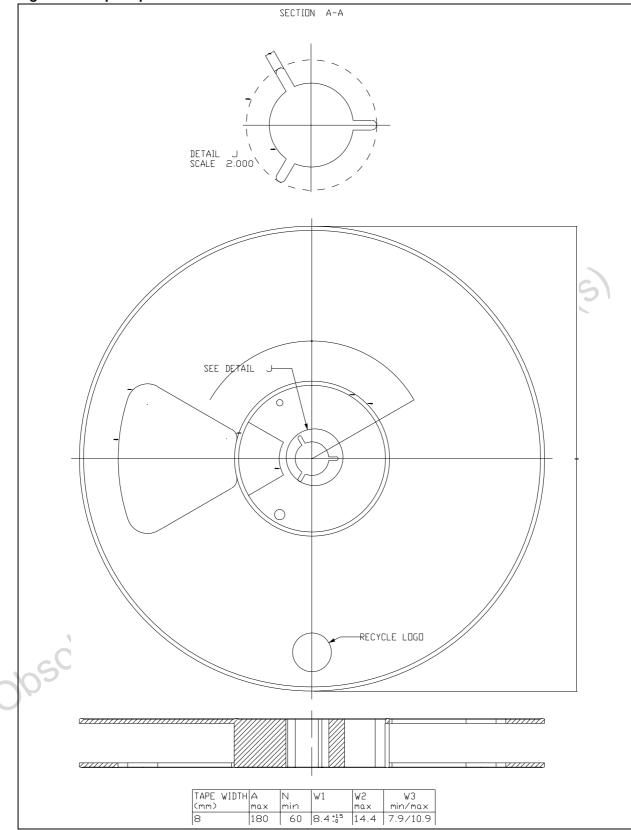




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### 6 Revision history

Table 10.Revision history

Date	Revision	Changes	
05-May-2006	1	First release	
22-Nov-2006	2	Schematic Figure 1 on page 3 updated	
17-Apr-2007	3	Typo in cover page description	

obsolete Product(s). Obsolete Product(s)



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